IRL520

Vishay Siliconix



TO-220AB

PRODUCT SUMMARY

V_{DS} (V) R_{DS(on)} (Ω)

Q_q (Max.) (nC)

Q_{gs} (nC)

Q_{gd} (nC)

Configuration

Power MOSFET

S

N-Channel MOSFET

0.27

100

12

3.0

7.1

Single

 $V_{GS} = 5.0 V$

FEATURES

- Dynamic dV/dt rating
- · Repetitive avalanche rated
- Logic-level gate drive
- R_{DS(on)} specified at V_{GS} = 4 V and 5 V
- 175°C operating temperature
- Fast switching
- Ease of paralleling
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

Note

* This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION	
Package	ТО-220АВ
Lead (Pb)-free	IRL520PbF
Lead (Pb)-free and halogen-free	IRL520PbF-BE3

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \degree C$, unless otherwise noted)								
PARAMETER		SYMBOL	LIMIT	UNIT				
Drain-source voltage		V _{DS}	100	v				
Gate-source voltage			V _{GS}	± 10	v			
Continuous drain current	V _{GS} at 5 V	T _C = 25 °C		9.2				
		T _C = 100 °C	ID	6.5	A			
Pulsed drain current ^a			I _{DM}	36	1			
Linear derating factor			0.40	W/°C				
Single pulse avalanche energy ^b			E _{AS}	170	mJ			
Repetitive avalanche current ^a			I _{AR}	9.2	А			
Repetitive avalanche energy ^a			E _{AR}	6.0	mJ			
Maximum power dissipation $T_{\rm C} = 25 ^{\circ}{\rm C}$			PD	60	W			
Peak diode recovery dV/dt c			dV/dt	5.5	V/ns			
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +175	°C				
Soldering recommendations (peak temperature) ^d	For 10 s			300 ^d				
Mounting torque	6-32 or M3 screw			10	lbf · in			
				1.1	N · m			

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. $V_{DD} = 25 \text{ V}$, starting $T_J = 25 \text{ °C}$, L = 3.0 mH, $R_g = 25 \Omega$, $I_{AS} = 9.2 \text{ A}$ (see fig. 12)

c.
$$I_{SD} \le 9.2$$
 A, dI/dt ≤ 110 A/µs, $V_{DD} \le V_{DS}$, $T_J \le 175$ °C

d. 1.6 mm from case

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THERMAL RESISTANCE RAT	INGS									
PARAMETER	SYMBOL	ТҮР		MAX.		UNIT				
Maximum junction-to-ambient	R _{thJA}	- 62			°C/W					
Case-to-sink, flat, greased surface	R _{thCS}	0.50 - 2.5								
Maximum junction-to-case (drain)	R _{thJC}									
	·									
SPECIFICATIONS (T _J = 25 $^{\circ}$ C, u	unless otherw	vise noted)								
PARAMETER	SYMBOL	TES		IONS	MIN.	TYP.	MAX.	UNIT		
Static	•	•								
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 2	250 μA	100	-	-	V		
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C,	I _D = 1 mA	-	0.12	-	V/°C		
Gate-source threshold voltage	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 2	250 μA	1.0	-	2.0	V		
Gate-source leakage	I _{GSS}	,	V _{GS} = ± 10 V			-	± 100	nA		
7		$\frac{V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}}{V_{DS} = 80 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 150 ^{\circ}\text{C}}$		_S = 0 V	-	-	25	μA		
Zero gate voltage drain current	IDSS			T _J = 150 °C	-	-	250			
Drain-source on-state resistance	D	$V_{GS} = 5.0 V$	I _D	= 5.5 A ^b	-	-	0.27	-		
	R _{DS(on)}	$V_{GS} = 4.0 V$	I _D	= 4.6 A ^b	-	-	0.38	Ω		
Forward transconductance	g _{fs}	V _{DS} :	= 50 V, I _D =	5.5 A	3.2	-	-	S		
Dynamic					•	•	•			
Input capacitance	C _{iss}		$V_{GS} = 0 V$,		-	490	-			
Output capacitance	C _{oss}		$V_{GS} = 0 V,$ $V_{DS} = 25 V,$ f = 1.0 MHz, see fig. 5		-	150	-	pF		
Reverse transfer capacitance	C _{rss}	f = 1.			-	30	-			
Total gate charge	Qg			-	-	12	nC			
Gate-source charge	Q _{gs}			A, V _{DS} = 80 V, g. 6 and 13 ^b	-	-		3.0		
Gate-drain charge	Q _{gd}	1			-	-		7.1		
Turn-on delay time	t _{d(on)}		•		-	9.8	-			
Rise time	t _r	$\label{eq:V_DD} \begin{array}{l} V_{DD} = 50 \; V, \; I_D = 9.2 \; A, \\ R_g = 9.0 \; \Omega, \; R_D = 5.2 \; \Omega, \; \text{see fig. 10}^{b} \end{array}$		-	64	-	ns			
Turn-off delay time	t _{d(off)}			-	21	-				
Fall time	t _f	1			-	27	-			
Internal drain inductance	L _D	Between lead, 6 mm (0.25") from		-	4.5	-	nH			
Internal source inductance	L _S	die contact			-	7.5		-		
Drain-Source Body Diode Characteristi	cs									
Continuous source-drain diode current	۱ _S	MOSFET symbol showing the		-	-	9.2	A			
Pulsed diode forward current ^a	I _{SM}	p - n junction diode			-	-		36		
Body diode voltage	V _{SD}	$T_J = 25 \ ^\circ C, \ I_S = 9.2 \ A, \ V_{GS} = 0 \ V^b$			-	-	2.5	V		
Body diode reverse recovery time	t _{rr}	T _J = 25 °C, I _F = 9.2 A, dl/dt = 100 A/µs ^b		-	130	190	ns			
Body diode reverse recovery charge	Q _{rr}	$r_{\rm J} = 25$ 0, $r_{\rm F} = 3.2$ Å, $u/ut = 100$ Å/ μ s			-	0.83	1.0	μC		
Forward turn-on time	t _{on}	Intrinsic turn-on time is negligible (turn			-on is dor	ninated b	by L _S and	L _D)		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Pulse width \leq 300 µs; duty cycle \leq 2 %

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

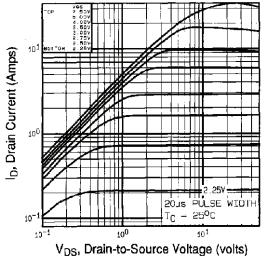
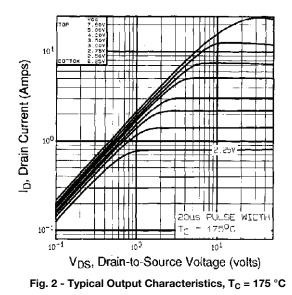
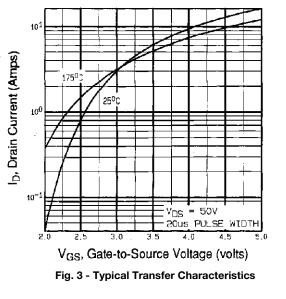


Fig. 1 - Typical Output Characteristics, $T_C = 25$ °C





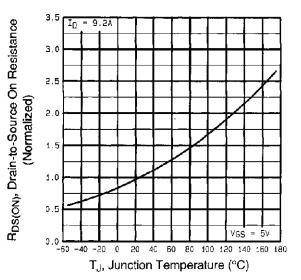


Fig. 4 - Normalized On-Resistance vs. Temperature

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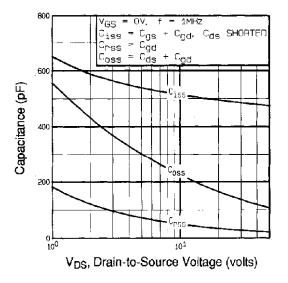


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

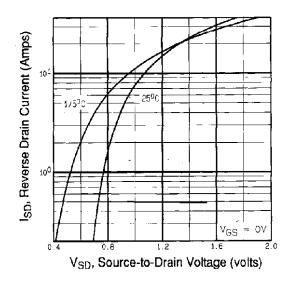


Fig. 7 - Typical Source-Drain Diode Forward Voltage

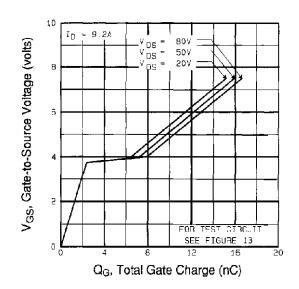


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

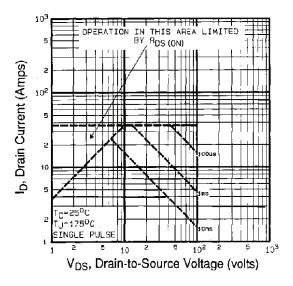


Fig. 8 - Maximum Safe Operating Area

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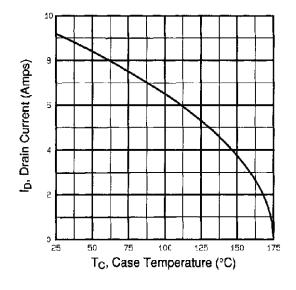


Fig. 9 - Maximum Safe Operating Area

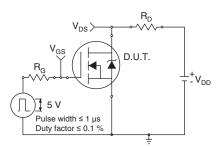


Fig. 10a - Switching Time Test Circuit

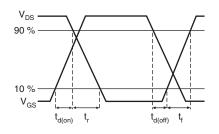


Fig. 10b - Switching Time Waveforms

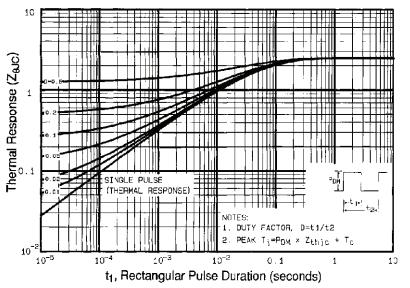


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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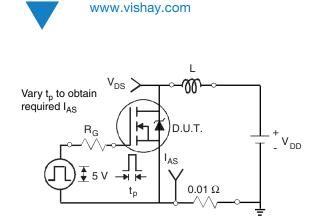


Fig. 12a - Unclamped Inductive Test Circuit

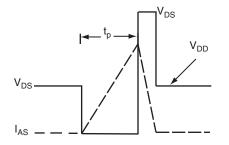


Fig. 12b - Unclamped Inductive Waveforms

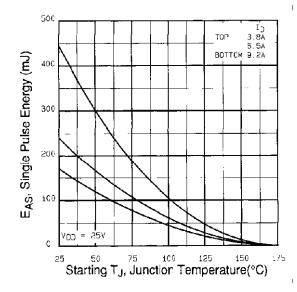


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

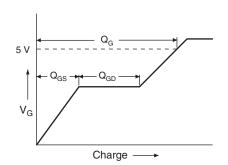
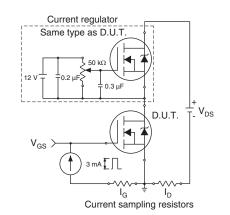


Fig. 13a - Basic Gate Charge Waveform





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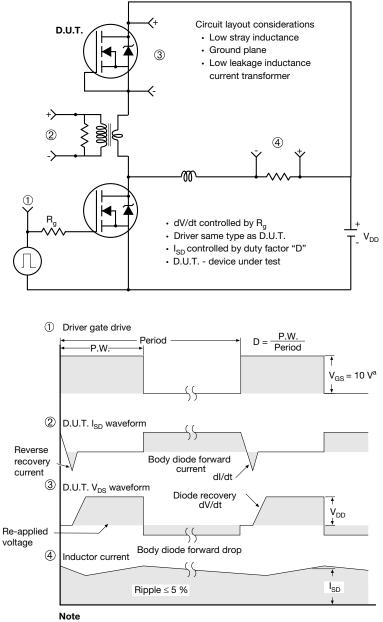
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Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

Fig. 14 - For N-Channel

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